



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Hsiao *et al.*  
Application No. : 10/748,262  
Filed : December 31, 2003  
Title : High Thermal Conductive Halogen-Free Phosphorus-Free Retardant Resin Composition For Printed Circuit Board Materials  
Group Art Unit : 1712  
Examiner : M. Feely  
Docket No. : BHT/3214-78

**MAIL STOP AMENDMENT**

Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Sir:

In response to the Office Action of August 25, 2005, the period for response to which has been extended to expire on **Jan. 25, 2006** by the filing herewith of a two month extension of time, please amend the above-identified application as follows: